

Marking Information



TG7 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: B = 2014)M = Month (ex: 9 = September)

Date Code Key

Year	201	4	2015		2016	20	17	2018		2019	2	2020
Code	В		С		D	[E	F		G		Н
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	Ω	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current	lpp	2.0	Α	8/20µs (Note 7)
ESD Protection – Contact Discharge	V _{ESD_Contact}	±12	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V_{ESD_Air}	±15	kV	Standard IEC 61000-4-2

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	300	mW
Thermal Resistance, Junction to Ambient T _A = +25°C	$R_{\theta JA}$	417	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

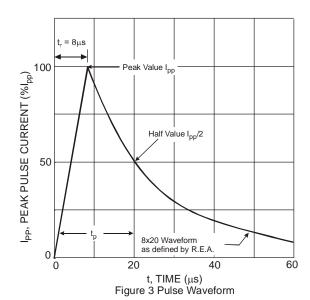
Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V_{RWM}		_	5.5	V	_
Channel Leakage Current (Note 6)	I_R		_	100	nA	$V_R = 5V$, Any I/O to GND
Reverse breakdown voltage	V_{BR}	6.0	_	_	V	$I_R = 1mA$
Forward voltage	V_{F}	-	0.85	_	V	$I_F = 4mA$
Clamping Voltage, Positive Transients (Note 7)	Vc		9.5	11.5	V	$I_{PP} = 1A$, $t_p = 8/20 \mu s$
Clamping voltage, Fositive Transients (Note 7)		_	10.5	12.5		$I_{PP} = 2A$, $t_p = 8/20 \mu s$
Channel Input Capacitance (Note 8)	Ст	ı	0.5	_	pF	$V_R = 0V$, $f = 1MHz$, Any I/O to GND
Chaine input Capacitance (Note o)	O _T	1	0.4	0.65	рι	$V_R = 2.5V$, $f = 1MHz$, Any I/O to GND
Dynamic Resistance	R_{DYN}	_	0.9	_	Ω	$I_{PP} = 1A$, $t_p = 8/20 \mu s$

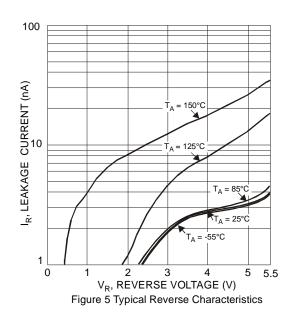
Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website
- at http://www.diodes.com. 6. Short duration pulse test used to minimize self-heating effect.
- 7. Clamping voltage value is based on an $8x20\mu s$ peak pulse current (I_{pp}) waveform. 8. Measured from any I/O to GND.
- 9. For information on the impact of Diodes' USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: http://www.diodes.com/destools/appnote_dnote.html.

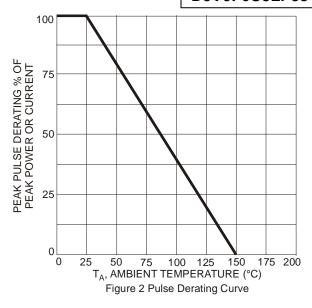


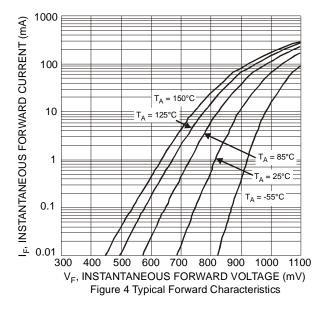
Note 5 350 P_D, POWER DISSIPATION (mW) 300 250 200 150 100 50 0 Ō 50 75 100 125 150 T_A, AMBIENT TEMPERATURE (°C) Figure 1 Power Derating Curve





D5V0F6U8LP33





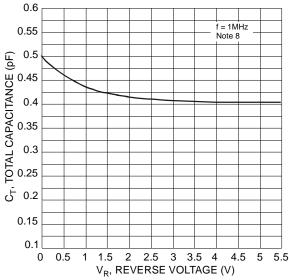
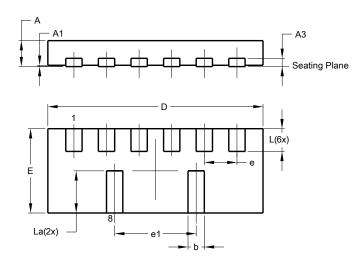


Figure 6 Total Capacitance vs. Reverse Voltage



Package Outline Dimensions

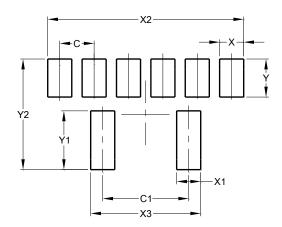
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X1-DFN3313-8						
Dim	Min	Max	Тур			
Α	0.37	0.43	0.40			
A1	0	0.05	0.02			
A2	-	-	0.13			
b	0.20	0.30	0.25			
D	3.25	3.38	3.30			
Е	1.25	1.38	1.30			
е	0.50 BSC					
e1	1.25 BSC					
L	0.30	0.43	0.38			
L1	0.57	0.70	0.65			
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
פווטופווסוטווס			
C	0.500		
C1	1.250		
X	0.350		
X1	0.350		
X2	2.850		
Х3	1.600		
Y	0.550		
Y1	0.850		
Y2	1.600		



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